

18. (Amended) A method for polishing a metal surface which is in contact with at least one member elected from the group consisting of silicon dioxide, silicon nitride and silicon oxynitride which method comprises providing on the metal surface a slurry comprising abrasive particles and a cationic polyelectrolyte in an amount sufficient to increase the polishing rate ratio of the metal to said member and contacting said surface with a polishing pad.

Please add new claims 22-36 as follows:

22. (New) The method of claim 13 wherein the polyelectrolyte has a molecular weight of about 300 to about 20,000.

23. (New) The method of claim 13 wherein the abrasive particles comprise a member selected from the group consisting of ceria, alumina, silica and zirconia.

24. (New) the method of claim 13 wherein the amount of abrasive particles is about 0.3 to about 2 percent by weight.

25. (New) The method of claim 13 wherein the amount of said polyelectrolyte is about 0.05 percent by weight.

26. (New) The method of claim 13 wherein the amount of said polyelectrolyte is about 0.05 to about 5 percent by weight.

27. (New) The method of claim 13 wherein the amount of polyelectrolyte is about 0.3 to about 1 percent by weight.

28. (New) The method of claim 18 wherein the polyelectrolyte has a weight of less than about 100,000.

29. (New) The method of claim 18 wherein the polyelectrolyte has a molecular weight of about 300 to about 20,000.

30. (New) The method of claim 23 wherein the abrasive particles comprise a member selected from the group consisting of ceria, alumina, silica and zirconia.

31. (New) The method of claim 24 wherein the amount of abrasive particles is about 0.3 to about 2 percent by weight.

32. (New) The method of claim 25 wherein the amount of said polyelectrolyte is about 0.05 percent by weight.

33. (New) The method of claim 26 wherein the amount of said polyelectrolyte is about 0.05 to about 5 percent by weight.

34. (New) The method of claim 27 wherein the amount of polyelectrolyte is about 0.3 to about 1 percent by weight.

35. (New) The method of claim 13 wherein the slurry is an aqueous slurry.

36. (New) The method of claim 23 wherein the slurry is an aqueous slurry.

REMARKS

Claims 1 and 13-36 are now in the application. Claims 13-36 are directed to the elected invention. Claim 1 is directed to a non-elected invention and may be canceled by the Examiner by allowance of the claims directed to the elected invention. Claims 13 and